

SLOVENSKI STANDARD oSIST prEN IEC 63171:2024

01-marec-2024

Konektorji za električno in elektronsko opremo - Zaslonjeni ali nezaslonjeni prosti in pritrjeni konektorji za podatkovne prenose po eni simetrični parici s tokovno zmogljivostjo - Splošne zahteve in preskusi

Connectors for electrical and electronic equipment - Shielded or unshielded free and fixed connectors for balanced single-pair data transmission with current-carrying capacity - General requirements and tests

Steckverbinder für elektrische und elektronische Geräte - Geschirmte oder ungeschirmte freie und feste Steckverbinder für symmetrische einpaarige Datenübertragung mit Stromtragfähigkeit - Allgemeine Anforderungen und Prüfungen

Connecteurs pour équipements électriques et électroniques - Fiches et embases écrantées ou non écrantées pour transmission de données sur une seule paire symétrique avec courant admissible - Exigences générales et essais

Ta slovenski standard je istoveten z: prEN IEC 63171:2024

ICS:

31.220.10 Vtiči in vtičnice, konektorji Plug-and-socket devices.

Connectors

oSIST prEN IEC 63171:2024 en

oSIST prEN IEC 63171:2024

iTeh Standards (https://standards.iteh.ai) Document Preview

oSIST prEN IEC 63171:2024

https://standards.iteh.ai/catalog/standards/sist/2e63cff3-fd86-46a7-a5a7-d8dd3488efad/osist-pren-iec-63171-2024

oSIST prEN IEC 63171:2024

PROJECT NUMBER: IEC 63171 ED2

DATE OF CIRCULATION:



48B/3079/CDV

COMMITTEE DRAFT FOR VOTE (CDV)

CLOSING DATE FOR VOTING:

| | 2024-01-05 | | 2024-03-29 | |
|---|------------------------------|--|--|--|
| | SUPERSEDES DOCUI | MENTS: | | |
| | 48B/3056/CD, 48 | BB/3075/CC | | |
| | | | | |
| IEC SC 48B : ELECTRICAL CONNECTORS | 3 | | | |
| SECRETARIAT: | | SECRETARY: | | |
| United States of America | | Mr Jeffrey Toran | | |
| OF INTEREST TO THE FOLLOWING COMMITTEES: | | PROPOSED HORIZONTAL STANDARD: | | |
| SC 46C,SC 65C,ISO/IEC JTC 1/SC 25 | | | | |
| | | Other TC/SCs are requested to indicate their interest, if any, in this CDV to the secretary. | | |
| FUNCTIONS CONCERNED: | | | | |
| ☐ EMC ☐ ENVIR | C | | ANCE SAFETY | |
| SUBMITTED FOR CENELEC PARALLEL VOTING NOT SUBMITTED FOR CENELEC PARALLEL VOTING | | FOR CENELEC PARALLEL VOTING | | |
| Attention IEC-CENELEC parallel voi | ting //gton | | toh oi) | |
| The attention of IEC National Committees, members of CENELEC, is drawn to the fact that this Committee Draft for Vote (CDV) is submitted for parallel voting. | | | | |
| The CENELEC members are invited to vote through the CENELEC online voting system. OSIST prEN | | | <u>1</u> | |
| tandards.iteh.ai/catalog/standard | ls/sist/2e63cff3- | fd86-46a7-a5a7 | 7-d8dd3488efad/osist-pren-iec- 6. | |
| This document is still under study and | I subject to change. | It should not be us | ed for reference purposes. | |
| Recipients of this document are invited to submit, with their comments, notification of any relevant patent rights of which they are aware and to provide supporting documentation. | | | | |
| Recipients of this document are invited to submit, with their comments, notification of any relevant "In Some Countries" clauses to be included should this proposal proceed. Recipients are reminded that the CDV stage is the final stage for submitting ISC clauses. (SEE AC/22/2007 OR NEW GUIDANCE DOC). | | | | |
| | | | | |
| TITLE: | | | | |
| Connectors for electrical and electronic equipment - Shielded or unshielded free and fixed connectors for balanced single-pair data transmission with current-carrying capacity - General requirements and tests | | | | |
| | | | | |
| PROPOSED STABILITY DATE: 2026 | | | | |
| | | | | |

Copyright © 2023 International Electrotechnical Commission, IEC. All rights reserved. It is permitted to download this electronic file, to make a copy and to print out the content for the sole purpose of preparing National Committee positions. You may not copy or "mirror" the file or printed version of the document, or any part of it, for any other purpose without permission in writing from IEC.

CONTENTS

| 2 | FOREWO |)RD | 4 |
|----|---------|--|-----------------------|
| 3 | INTRODU | JCTION | 6 |
| 4 | 1 Scor | De | 8 |
| 5 | • | native references | |
| 6 | | ns and definitions | |
| | | mon features and typical connector pair | |
| 7 | | | |
| 8 | | acteristics | |
| 9 | 5.1 | General | |
| 10 | 5.2 | Pin assignment | |
| 11 | 5.3 | Temperature related tests | |
| 12 | 5.3. | 3 , | |
| 13 | 5.3.2 | Rapid change of temperature | 11 |
| 14 | 5.4 | Electrical characteristics | 12 |
| 15 | 5.4. | Creepage and clearance distances | 12 |
| 16 | 5.4.2 | 2 Voltage proof | 12 |
| 17 | 5.4.3 | Current-temperature derating | 12 |
| 18 | 5.4.4 | Interface contact resistance – initial only | 14 |
| 19 | 5.4.5 | Input to output DC resistance | 14 |
| 20 | 5.4.6 | Input to output DC resistance unbalance | 15 |
| 21 | 5.4.7 | Insulation resistance | 15 |
| 22 | 5.5 | Transmission characteristics (data transmission portion for a combined | |
| 23 | | connector) | 15 |
| 24 | 5.5. | General Genera | 15 |
| 25 | 5.5.2 | Insertion loss | 16 |
| 26 | 5.5.3 | | |
| 27 | 5.5.4 | Propagation delay | 17 |
| 28 | 5.5.5 | Transverse conversion loss | 17 |
| 29 | 5.5.6 | Transverse conversion transfer loss | 1-1eg-631/1-202 17 |
| 30 | 5.5.7 | 7 Transfer impedance (shielded only) | 18 |
| 31 | 5.5.8 | Coupling attenuation (shielded only) | 18 |
| 32 | 5.5.9 | Power sum alien (exogenous) NEXT | 19 |
| 33 | 5.5. | , , | |
| 34 | 5.6 | Mechanical characteristics (data transmission portion for a combined | |
| 35 | | connector) | |
| 36 | 5.6. | · | |
| 37 | 5.6.2 | | |
| 38 | 5.6.3 | Insertion and withdrawal forces | 21 |
| 39 | 5.6.4 | Polarizing method | 21 |
| 40 | 5.6.5 | 5 Vibration | 21 |
| 41 | 5.6.6 | S Shock | 22 |
| 42 | 6 Test | s and test schedule | 22 |
| 43 | 6.1 | General | 22 |
| 44 | 6.2 | Example of an arrangement for input to output DC resistance measurement | 23 |
| 45 | 6.3 | Example of arrangement for interface contact resistance measurement | |
| 46 | 6.4 | Arrangement for vibration test (test phase CP) | |
| 47 | 6.5 | Test procedures and measuring methods | |
| 48 | 6.6 | Preconditioning | 25 |

| 49 | 6.7 Test schedules | 25 |
|----------|---|------------------------|
| 50 | 6.7.1 General | 25 |
| 51 | 6.7.2 Basic (minimum) test schedule | 25 |
| 52 | 6.7.3 Full test schedule | 25 |
| 53 | Annex A (informative) Current detail specifications | 33 |
| 54 | Bibliography | 36 |
| 55 | | |
| 56 | Figure 1 – Relationship between the IEC 63171 series and their related references | 7 |
| 57 | Figure 2 – Example of front view of fixed connector pin assignment | |
| 58 | Figure 3 – Level I connector derating curve | 13 |
| 59 | Figure 4 – Level II connector derating curve | 14 |
| 60 | Figure 5 – Example of an arrangement for input to output DC resistance measurement. | 23 |
| 61 | Figure 6 – Example of arrangement for contact resistance measurement | 24 |
| 62 | | |
| 63 | Table 1 – Climatic categories – selected values | 11 |
| 64 | Table 2 – Maximum insertion loss | 16 |
| 65 | Table 3 – Minimum return loss | 16 |
| 66 | Table 4 – Minimum transverse conversion loss | 17 |
| 67 | Table 5 – Minimum transverse conversion transfer loss | 17 |
| 68 | Table 6 – Maximum transfer impedance (shielded only) | 18 |
| 69 | Table 7 – Minimum coupling attenuation (shielded only) | 18 |
| 70 | Table 8 – Minimum power sum alien near end crosstalk (PS ANEXT) | 19 |
| 71 | Table 9 – Minimum power sum alien far end crosstalk (PS AFEXT) | 19 |
| 72 | Table 10 – Preferred values for the number of mating cycles | 20 |
| 73 | Table 11 – Minimum pull-out force | 21 |
| 74 | Table 12 – Test group PSIST. MEM. IEG. 63.1.71.2024 | 26 |
| ht/758:/ | Table 13 - Test group AP undards/sist/2e63cff3-fd86-46a7-a5a7-d8dd3488cfad/osist-pn | en.ie 26 3171-2 |
| 76 | Table 14 – Test group BP | 28 |
| 77 | Table 15 – Test group CP | 29 |
| 78 | Table 16 – Test group DP | 30 |
| 79 | Table 17 – Test group EP | |
| 80 | Table 18 – Test group FP | |
| 81 | Table 19 – Test group GP | 32 |
| 82 | Table A 1 – Overview of current detail specifications | 33 |

48B/3079/CDV

INTERNATIONAL ELECTROTECHNICAL COMMISSION

85 86

87

88

89

84

CONNECTORS FOR ELECTRICAL AND ELECTRONIC EQUIPMENT – Shielded or unshielded free and fixed connectors for balanced single-pair data transmission with current carrying capacity – General requirements and tests

90 91

92

93

94 95

96

97

98 99

100 101

102

103

104

105

106

107

108

109

110 111

112 113

114

115

FOREWORD

- 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
- 2) The formal decisions or agreements of IEC on technical matters express, as nearly as possible, an international consensus of opinion on the relevant subjects since each technical committee has representation from all interested IEC National Committees.
- 3) IEC Publications have the form of recommendations for international use and are accepted by IEC National Committees in that sense. While all reasonable efforts are made to ensure that the technical content of IEC Publications is accurate, IEC cannot be held responsible for the way in which they are used or for any misinterpretation by any end user.
- 4) In order to promote international uniformity, IEC National Committees undertake to apply IEC Publications transparently to the maximum extent possible in their national and regional publications. Any divergence between any IEC Publication and the corresponding national or regional publication shall be clearly indicated in the latter.
- 5) IEC itself does not provide any attestation of conformity. Independent certification bodies provide conformity assessment services and, in some areas, access to IEC marks of conformity. IEC is not responsible for any services carried out by independent certification bodies.
- 6) All users should ensure that they have the latest edition of this publication.
- 7) No liability shall attach to IEC or its directors, employees, servants or agents including individual experts and members of its technical committees and IEC National Committees for any personal injury, property damage or other damage of any nature whatsoever, whether direct or indirect, or for costs (including legal fees) and expenses arising out of the publication, use of, or reliance upon, this IEC Publication or any other IEC Publications.
- 121 8) Attention is drawn to the Normative references cited in this publication. Use of the referenced publications is indispensable for the correct application of this publication.
- 123 9) Attention is drawn to the possibility that some of the elements of this IEC Publication may be the subject of patent rights. IEC shall not be held responsible for identifying any or all such patent rights.
- 125 IEC 63171 has been prepared by subcommittee 48B: Electrical connectors, of IEC technical committee 48: Electrical connectors and mechanical structures for electrical and electronic equipment. It is an International Standard.
- This 2nd edition cancels and replaces the 1st edition published in 2021. This edition constitutes a technical revision.
- This edition includes the following significant technical changes with respect to the previous edition:
- a) adding content related to multipole and combined connectors;
- b) alignment of transmission requirements with ISO/IEC 11801-1 AMD1;
- c) updating and reorganising of the test groups.
- The text of this International Standard is based on the following documents:

| Draft | Report on voting |
|------------|------------------|
| XX/XX/FDIS | XX/XX/RVD |

- Full information on the voting for its approval can be found in the report on voting indicated in the above table.
- 139 The language used for the development of this International Standard is English.
- This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at www.iec.ch/members experts/refdocs. The main document types developed by IEC are
- described in greater detail at www.iec.ch/publications.
- The committee has decided that the contents of this document will remain unchanged until the stability
- date indicated on the IEC website under webstore.iec.ch in the data related to the specific document.
- 146 At this date, the document will be
- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- 150 amended.

iTeh Standards (https://standards.iteh.ai) Document Preview

oSIST prEN IEC 63171:2024

https://standards.iteh.ai/catalog/standards/sist/2e63cff3-fd86-46a7-a5a7-d8dd3488efad/osist-pren-iec-63171-2024

| 151 | INTRODUCTION |
|--------------------------|--|
| 52 53 54 55 | This document, identified as IEC 63171, is the general requirements and general tests part (general specification) of the whole IEC 63171 series, a set of International Standards covering shielded or unshielded free and fixed connectors for balanced single-pair data transmission with current carrying capacity. |
| 156 | It provides the signal integrity requirements, common to the whole series. |
| 57 58 59 | Subsequent parts, identified as IEC 63171 followed by a dash and a progressive number starting with 1, are the product detail specifications of this series and do not duplicate information given in this document, but list only additional requirements. |
| 160 161 162 | Each subsequent part is identified by a type of connector – or a set of connectors – covered with the same number identifying the part. Some parts can describe more connector geometries (rectangular, circular), sharing the core element and the relevant features. |
| 163 164 165 | Other requirements, which are necessary to describe e.g., additional power portion – if any of that connector, can be covered by referencing requirements provided by other relevant documents, e.g.: IEC 61076-2 or IEC 61076-3, and/or IEC 61984, as applicable. |
| 166 167 168 169 | For the complete specifications regarding a connector of this series, as well as of other series calling up this document for the signal integrity requirements, both this product general specification and the relevant detail specification, as well as any other sectional specification and/or safety requirement document referenced in the relevant subsequent part of this series or in the relevant product detail specification, are therefore required. |
| 71 72 73 | For the qualification of a connector of this series, both this general specification and the relevant detail specification – including the references made therein, if any, to other sectional specification and/or other safety-related documents – shall be met. |

Figure 1 shows the interrelation of the standards within this series:

oSIST prEN IEC 63171:2024

https://standards.iteh.ai/catalog/standards/sist/2e63cff3-fd86-46a7-a5a7-d8dd3488efad/osist-pren-jec-63171-2024

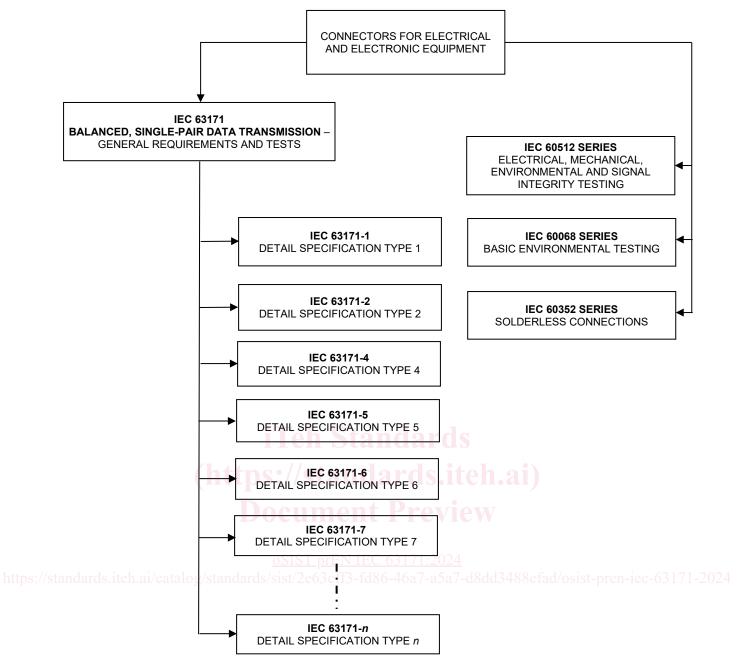


Figure 1 - Relationship between the IEC 63171 series and their related references

CONNECTORS FOR ELECTRICAL AND ELECTRONIC EQUIPMENT –
Shielded or unshielded free and fixed connectors for balanced
single-pair data transmission with current carrying capacity –
General requirements and tests

179 180

181

202

176

177

178

1 Scope

- This document covers shielded and unshielded free and fixed connectors, circular or rectangular, for balanced single-pair data transmission, with current-carrying capacity.
- 184 It also covers the portion for balanced single-pair data transmission of combined, shielded or
- unshielded, free and fixed connectors, circular or rectangular, having additional contacts for
- power transmission, whose performance requirements are described in a detail specification of
- the IEC 63171-X series, (type X connectors), or in a separate document, either IEC detail
- specification or manufacturer's specification.
- 189 It specifies the IEC 63171 series' or of other document referencing it common mechanical,
- 190 electrical and transmission characteristics and environmental requirements, as well as required
- 191 test specifications.
- 192 This document does not describe a specific mating interface. Detail specifications of mating
- interfaces complying with this document can be found in the family of detail specification
- standards IEC 63171-X (type X connectors) or in a separate document, either IEC detail
- specification or manufacturer's specification.
- 196 Within their own type, the shielded and unshielded connectors are interoperable for their
- transmission performance and can be exchanged, though the shielded version has improved
- alien crosstalk and coupling attenuation properties.
- Single-pair connectors of this series might be grouped to one body of multipole connectors or
- combined with other connectors, e.g., power connectors, also known as combined (data or
- 201 signal, and power) connectors.

2 Normative references

- 203 The following documents are referred to in the text in such a way that some or all of their content
- constitutes requirements of this document. For dated references, only the edition cited applies.
- 205 For undated references, the latest edition of the referenced document (including any
- amendments) applies.
- 207 IEC 60050-581, International Electrotechnical Vocabulary (IEV) Part 581: Electromechanical
- 208 components for electronic equipment
- 209 IEC 60068-1:2013, Environmental testing Part 1: General and guidance
- 210 IEC 60512-1, Connectors for electrical and electronic equipment Tests and measurements –
- 211 Part 1: Generic specification
- IEC 60512-1-1, Connectors for electronic equipment Tests and measurements Part 1-1:
- 213 General examination Test 1a: Visual examination
- 214 IEC 60512-2-1, Connectors for electronic equipment Tests and measurements Part 2-1:
- 215 Electrical continuity and contact resistance tests Test 2a: Contact resistance Millivolt level
- 216 method
- 217 IEC 60512-2-5, Connectors for electronic equipment Tests and measurements Part 2-5:
- 218 Electrical continuity and contact resistance tests Test 2e: Contact disturbance

- 219 IEC 60512-3-1, Connectors for electronic equipment Tests and measurements Part 3-1:
- 220 Insulation tests Test 3a: Insulation resistance
- IEC 60512-4-1, Connectors for electronic equipment Tests and measurements Part 4-1:
- 222 Voltage stress tests Test 4a: Voltage proof
- 1EC 60512-5-2, Connectors for electronic equipment Tests and measurements Part 5-2:
- 224 Current-carrying capacity tests Test 5b: Current-temperature derating
- 225 IEC 60512-6-4, Connectors for electronic equipment Tests and measurements Part 6-4:
- 226 Dynamic stress tests Test 6d: Vibration (sinusoidal)
- 227 IEC 60512-9-1, Connectors for electronic equipment Tests and measurements Part 9-1:
- 228 Endurance tests Test 9a: Mechanical operation
- 229 IEC 60512-9-2, Connectors for electronic equipment Tests and measurements Part 9-2:
- 230 Endurance tests Test 9b: Electrical load and temperature
- 231 IEC 60512-11-1, Connectors for electronic equipment Tests and measurements Part 11-1:
- 232 Climatic tests Test 11a Climatic sequence
- 233 IEC 60512-11-4, Connectors for electronic equipment Tests and measurements Part 11-4:
- 234 Climatic tests Test 11d: Rapid change of temperature
- 235 IEC 60512-11-7, Connectors for electronic equipment Tests and measurements Part 11-7:
- 236 Climatic tests Test 11g: Flowing mixed gas corrosion test
- 237 IEC 60512-11-12, Connectors for electronic equipment Tests and measurements -
- 238 Part 11-12: Climatic tests Test 11m: Damp heat, cyclic
- 239 IEC 60512-13-2, Connectors for electronic equipment Tests and measurements Part 13-2:
- 240 Mechanical operation tests Test 13b: Insertion and withdrawal forces
- 241 // IEC 60512-15-6, Connectors for electronic equipment Tests and measurements Part 15-6: 3171-2024
- 242 Connector tests (mechanical) Test 15f: Effectiveness of connector coupling devices
- 243 IEC 60512-25-9, Connectors for electronic equipment Tests and measurements Part 25-9:
- 244 Signal integrity tests Test 25i: Alien crosstalk
- IEC 60512-26-100, Connectors for electronic equipment Tests and measurements Part 26-
- 246 100: Measurement setup, test and reference arrangements and measurements for connectors
- 247 according to IEC 60603-7 Tests 26a to 26g
- 248 IEC 60512-28-100, Connectors for electronic equipment Tests and measurements –
- Part 28-100: Signal integrity tests up to 2 000 MHz Tests 28a to 28g
- 1EC 60664-1, Insulation coordination for equipment within low-voltage systems Part 1:
- 251 Principles, requirements and tests
- 252 IEC 61156 (all parts), Multicore and symmetrical pair/quad cables for digital communications
- 253 IEC 61984, Connectors Safety requirements and tests
- 1EC 62153-4-9:2018/AMD1:2020, Metallic communication cable test methods Part 4-9:
- 255 Electromagnetic compatibility (EMC) Coupling attenuation of screened balanced cables,
- 256 triaxial method